

Surface Mount PTC

OZCF Series

HF  OZCF Series – 2920 Chip

RoHS 2 Compliant

Application

All high-density boards

Product Features

- 2920 Chip Size, Fast Trip Time, High Hold Currents
- AEC-Q Compliant
- Meets Bel automotive qualification*
 - * - Largely based on internal AEC-Q test plan

Operating (Hold Current) Range

300mA - 3A

Maximum Voltage

6 - 60V (per table)

Temperature Range

-40°C to 85°C

Agency Approval

TUV (Std. EN60738-1-1, Cert. R50102117)

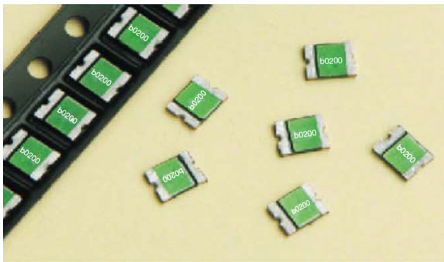
UL Recognized Component (Std. UL1434, File E305051)

UL Conditions of Acceptability:

1. These devices have been investigated for use in safety circuits and are suitable as a limiting device.
2. These devices have been calibrated to limit the current to 8 amps within 5 seconds, per ANSI/NFPA 70, "National Electrical Code".



LEAD FREE = 

HALOGEN FREE = 



AEC-Q Compliant

Electrical Characteristics (23°C)

	Part Number	Hold Current	Trip Current	Rated Voltage	Maximum Current	Typical Power	Max Time to Trip		Resistance Tolerance		Agency Approvals	
		I _H , A	I _T , A	V _{max} , V _{dc}	I _{max} , A	P _d , W	Current A	Time Sec	R _{min} Ohms	R _{1max} Ohms		
A	OZCF0030FF2C	0.30	0.60	60	100	1.5	1.5	3.0	1.000	4.800	Y	Y
B	OZCF0050FF2C	0.50	1.00	60	100	1.5	2.5	4.0	0.300	1.400	Y	Y
C	OZCF0075FF2C	0.75	1.50	33	100	1.5	8.0	0.3	0.180	1.000	Y	Y
	OZCF0075AF2C	0.75	1.50	60	100	1.5	8.0	0.3	0.180	1.000	Y	Y
D	OZCF0100AF2A	1.00	2.00	60	100	1.5	8.0	0.5	0.090	0.410	Y	Y
	OZCF0110FF2C	1.10	2.20	33	100	1.5	8.0	0.5	0.090	0.410	Y	Y
E	OZCF0125FF2C	1.25	2.50	33	100	1.5	8.0	2.0	0.050	0.250	Y	Y
F	OZCF0150FF2C	1.50	3.00	33	100	1.5	8.0	2.0	0.050	0.230	Y	Y
G	OZCF0185FF2C	1.85	3.70	33	100	1.5	8.0	2.5	0.040	0.150	Y	Y
H	OZCF0200FF2C	2.00	4.00	16	100	1.5	8.0	4.5	0.035	0.120	Y	Y
	OZCF0200AF2C	2.00	4.00	24	100	1.5	8.0	5.0	0.035	0.120	Y	Y
I	OZCF0250FF2C	2.50	5.00	16	100	1.5	8.0	16.0	0.025	0.085	Y	Y
J	OZCF0260FF2C	2.60	5.20	6	100	1.5	8.0	20.0	0.020	0.075	Y	Y
	OZCF0260AF2C	2.60	5.20	24	100	1.5	8.0	20.0	0.020	0.075	Y	Y
K	OZCF0300FF2C	3.00	5.20	6	100	1.5	8.0	25.0	0.010	0.048	Y	Y
	OZCF0300AF2C	3.00	5.20	15	100	1.5	8.0	20.0	0.010	0.048	Y	Y
	OZCF0300BF2C	3.00	5.20	24	100	1.5	8.0	20.0	0.010	0.048	Y	Y

I_H Hold Current-maximum current at which the device will not trip in still air at 23°C.

I_T Trip current-minimum current at which the device will always trip in still air at 23°C.

I_{max} Maximum fault current device can withstand without damage at rated voltage (V_{max}).

V_{max} Maximum voltage device can withstand without damage at its rated current.

P_d Typical power dissipated by device when in tripped state in 23°C still air environment.

R_{min} Minimum device resistance at 23°C.

R_{1max} Maximum device resistance at 23°C, 1 hour after initial device trip, or after being soldered to PCB in end application.

PTC's – Basic Theory of Operation / “Tripped” Resistance Explanation

Fundamentally, a Bel PTC consists of a block of polymeric material containing conductive filler and bonded between two conductive, planar terminations.

At currents below the device I_{HOLD} rating, AND at temperatures below 100C, the PTC maintains a resistance value below its R_{1 MAX} rating.

As the device's temperature approaches 130C, either due to an increase in ambient temperature or a current exceeding its I_{TRIP} rating, volumetric expansion of the filled polymer breaks apart the majority of conductive pathways across the terminals created by chain contact of adjacent filler particles or device resistance increases sharply by several orders of magnitude.

At the much higher “Tripped” resistance, there is just enough leakage current to allow internal heating to “hold” the device in its tripped state (around 125C) until power is interrupted. Once power is removed, the PTC's core cools and contracts allowing conductive chains to reform and return the device to its low resistance state.

The catalog data for each device specifies a “Typical Power” value. This is the power required to exactly match the heat lost by the tripped device to its ambient surroundings at 23C. By Ohm's Law, power can be stated as: $W = E^2/R$. Thus the approximate resistance of a “Tripped” PTC can be determined by: $R = E^2/W$, where “E” is the voltage appearing across the PTC (usually the supply's open circuit voltage), and “W” is the Typical Power value for the particular PTC.

Since the PPTC acts to maintain a constant internal temperature, its apparent resistance will change based upon applied voltage and, to a lesser degree, ambient conditions. Consider the following example....

A PTC with a Typical Power of 1 watt protecting a circuit using a 60V supply will demonstrate an apparent, tripped resistance “R” of:

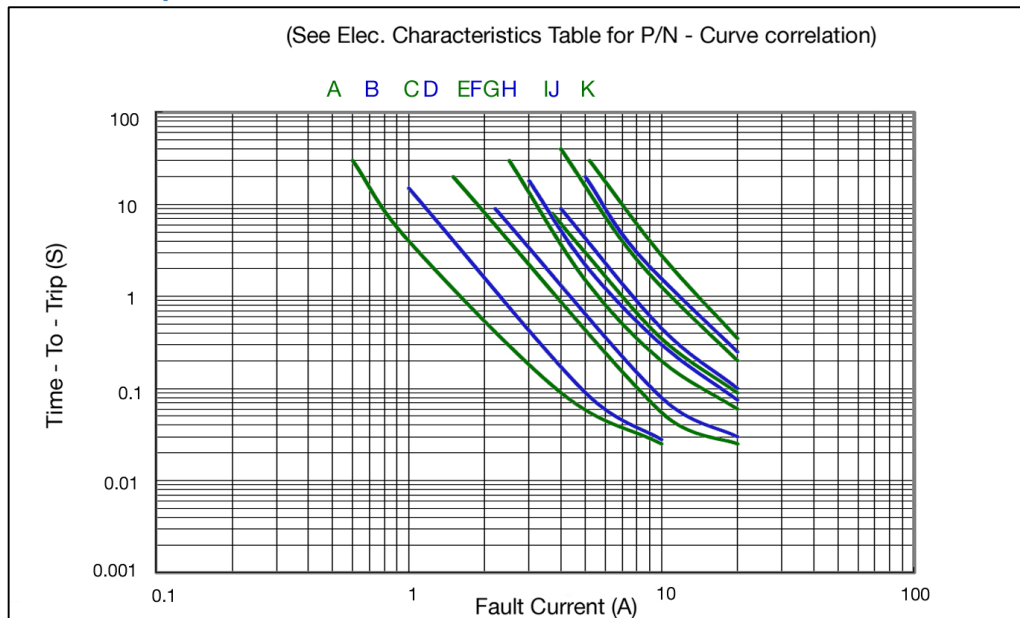
$$R = 60^2/1 = 3,600 \text{ ohms}$$

This same tripped device when used to protect a 12V circuit would now present an apparent resistance of:

$$R = 12^2/1 = 144 \text{ ohms}$$

The value for Typical Power is “typical” because any physical factors that affect heat loss (such as ambient temperature or air convection) will somewhat alter the level of power that the PTC needs to maintain its internal temperature. In short, PTCs do not exhibit a constant, quantifiable tripped resistance value.

Type Time – To – Trip at 23°C



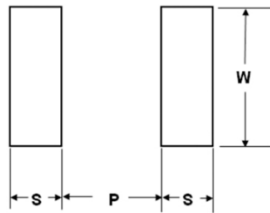
Specifications subject to change without notice

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Pad Layout

The dimensions in the table below provide the recommended pad layout.



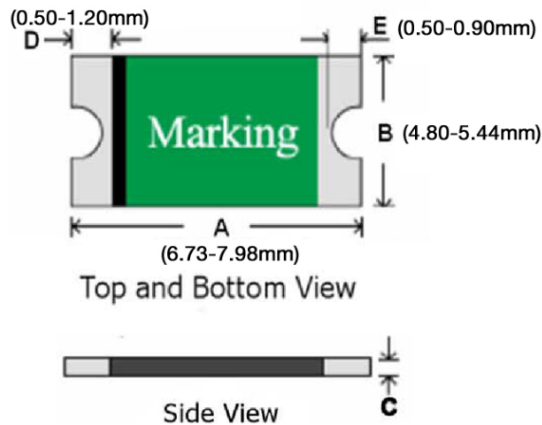
P		S		W	
Nominal		Nominal		Nominal	
mm	Inch	mm	Inch	mm	Inch
5.10	0.201	2.30	0.091	5.60	0.221

Termination Pad Materials

Matte Tin – Plated Copper

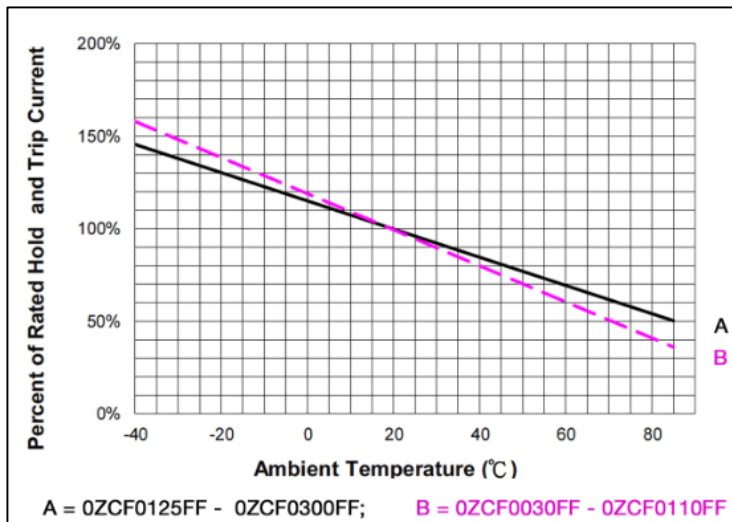
Mechanical Dimensions and Marking

All dimensions in mm.



Part Number	Dimensions		Marking Code	
	C		"b", LH code	
	Min	Max	bXXXX	bXXX XX
0ZCF0030FF2C	0.60	1.15	0030	
0ZCF0050FF2C	0.60	1.15	0050	
0ZCF0075FF2C	0.40	1.15	0075	
0ZCF0075AF2C	0.60	1.15		0075 60
0ZCF0100AF2A	0.40	1.70		0100 60
0ZCF0110FF2C	0.40	1.00	0110	
0ZCF0125FF2C	0.40	0.90	0125	
0ZCF0150FF2C	0.40	0.90	0150	
0ZCF0185FF2C	0.30	0.90	0185	
0ZCF0200FF2C	0.30	0.90	0200	
0ZCF0200AF2C	0.20	0.80		0200 24
0ZCF0250FF2C	0.30	0.90	0250	
0ZCF0260FF2C	0.30	0.90	0260	
0ZCF0260AF2C	0.65	1.15		0260 24
0ZCF0300FF2C	0.40	0.90	0300	
0ZCF0300AF2C	0.40	1.15		0300 15
0ZCF0300BF2C	0.65	1.15		0300 24

Thermal Derating Curve



Cautionary Notes

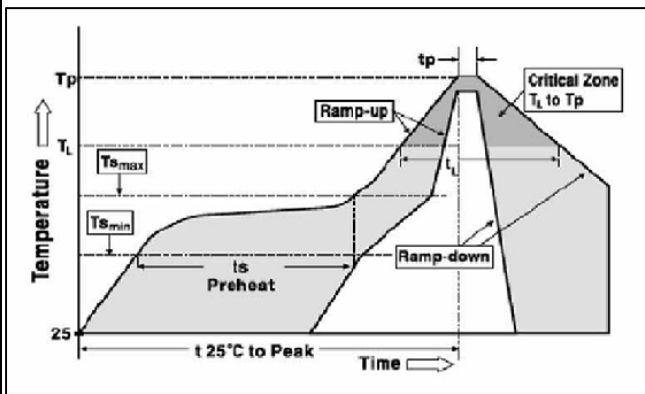
1. Operation beyond the specified maximum ratings or use may result in damage and possible electrical arcing and/or flame.
2. These Polymer PTC (PPTC) devices are intended for protection against occasional overcurrent/ overtemperature fault conditions and may not be suitable for use in applications where repeated and/or prolonged fault conditions are anticipated.
3. Avoid contact of PTC device with chemical solvent. Prolonged contact may adversely impact the PTC performance.
4. These PTC devices may not be suitable for use in circuits with a large inductance, as the PTC trip can generate circuit voltage spikes above the PTC rated voltage.
5. These devices are intended for use in DC voltage applications only. Use in AC voltage applications should be first discussed with Bel Fuse engineering.
6. Not recommended for use on potted or conformal coated PCB's. Restriction of free air flow could affect electrical performance and/or result in device failure. Consult Bel Fuse engineering.
7. MSL: 2a (According to IPC J-Std-020).

Environmental Specifications

Temperature cycling	JESD22 Method JA-104
Biased humidity	MIL-STD-202 Method 103
Operational life	MIL-STD-202 Method 108
Resistance to solvents	MIL-STD-202 Method 215
Mechanical shock	MIL-STD-202 Method 213
Vibration	MIL-STD-202 Method 204
Resistance to soldering heat	MIL-STD-202 Method 210
Thermal shock	MIL-STD-202 Method 107
Solderability	ANSI/J-STD-002
Board flex(SMD)	AEC-Q200-005
Terminal strength	AEC-Q200-006

Solder Reflow and Rework Recommendations

Profile Feature	Pb-Free Assembly
Average Ramp-Up Rate (T _{smax} to T _p)	3°C/second max
Preheat :	
Temperature Min (T _{smin})	150°C
Temperature Max (T _{smax})	200°C
Time (t _{smin} to t _{smax})	60-180 seconds
Time maintained above:	
Temperature(T _L)	217°C
Time (t _L)	60-150 seconds
Peak/Classification Temperature(T _p) :	260°C
Time within 5°C of actual Peak :	
Temperature (t _p)	20-40 seconds
Ramp-Down Rate :	6°C/second max.
Time 25°C to Peak Temperature :	8 minutes max



Solder Reflow

Due to "lead free / RoHS 2" construction of these PTC devices, the required Temperature and Dwell Time in the "Soldering" zone of the reflow profile are greater than those used for non-RoHS devices.

1. Recommended reflow methods; IR, vapor phase oven, hot air oven.
2. Not Recommended For Wave Solder / Direct Immersion.
3. Recommended paste thickness range – 0.20 – 0.25mm.
4. Devices are compatible with standard industry cleaning solvents and methods.
5. MSL: 2a (According to IPC J-Std-020).

Caution

If reflow temperature / dwell times exceed the recommended profile, the electrical performance of the PTC may be affected.

Rework: MIL-STD-202G Method 210F, Test Condition A.

Standard Packaging

Part Number	Tape/Reel Qty
0ZCF0030FF2C Thru 0ZCF0075AF2C	2,000
0ZCF0100AF2A	1,000
0ZCF0110FF2C Thru 0ZCF0300BF2C	2,000

2000 or 1000 fuses in 7 inches dia. Reel, 8mm wide tape, 4mm pitch, per EIA-481 (equivalent IEC-286 part 3).

P/N Explanation and Ordering Information

	<u>0ZCF</u>	<u>0XXX</u>	<u>X</u>	<u>X</u>	<u>XX</u>
PTC series	0ZCF, 2920 Size				
I HOLD Rating	Refer to Part Number and IH Rating in Electrical Characteristics Table on P.1.				
Electrical Characteristics	F = Standard Design A to Z (except F) = Special, customer spec, DCR sort, etc.				
Mechanical Features	F = Standard Design A to Z (except F) = Special, customer spec, lead forming, etc.				
Tape & Reel Qty	See standard packaging				



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